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## PATENT ABSTRACTS OF JAPAN

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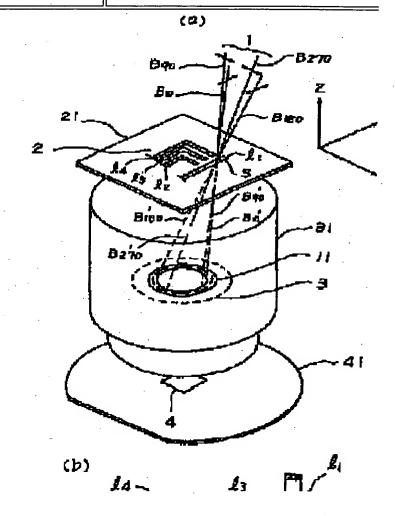
(74) Representative:

(54) METHOD AND APPARATUS FOR EXPOSING PATTERN, MASK USED THEREFOR AND SEMICONDUCTOR INTEGRATED CIRCUIT FORMED BY USING THE SAME

(57) Abstract:

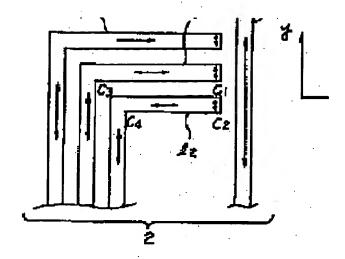
PURPOSE: To realize a resolution equivalent to a phase shifting method or more without generating a pattern impossible to design by using a pattern depending polarization mask for applying polarization characteristics responsive to a direction of the pattern on the mask to an illumination light passed through the pattern.

CONSTITUTION: B0 B90, B180, B270 of partial lights of an illumination light respectively have linear polarizations, and emit a ring



bandlike band like an illumination light 11 on a pupil of a reducing lens 31 of a projecting optical system when there is no mask 2. Patterns 11, 12, 13, 14 directed in directions (x) and (y) are, for example, formed on the mask 2 by lithography, and polarization characteristics responsive to the directions of the patterns are applied to a light emitted to and passed through the patterns. Thus, the pattern having much excellent resolution as compared with conventional resolution pattern can be exposed by using a projecting optical system of a conventional exposure apparatus as it is.

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## **KOREAN PATENT ABSTRACTS**

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(71) Applicant:

**HYUNDAI MICRO ELECTRONICS** 

CO., LTD.

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YOON, JIN YEONG

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## (54) POLARIZING MASK

## (57) Abstract:

PURPOSE: A polarizing mask is provided to improve a characteristic of a semiconductor device by preventing an interference effect between a light transmitting a mask and an adjacent light.

CONSTITUTION: A polarizing mask comprises a polarizing plate(10), an upper polarizing pattern(20), and a lower polarizing pattern(30,40). The polarizing plate(10) polarizes an incident light at 45 degrees. The upper polarizing pattern(20) has a predetermined structure formed on an upper portion of the polarizing plate(10) in order to intercept a received light. The lower polarizing pattern(30,40) is formed between each upper polarizing plate(20). The lower polarizing pattern(30,40) polarizes the light transmitting the polarizing plate(10) to a predetermined angle.

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